## Surface Mount **RF Transformer**

50Ω

### 2 to 1100 MHz

#### **Maximum Ratings**

Operating Temperature	-20°C to 85°C			
Storage Temperature	-55°C to 100°C			
RF Power	0.25W			
DC Current	30mA			
Permanent damage may occur if any of these limits are exceeded.				

#### Pin Connections

(.030X.075)MIN

PRIMARY DOT	6
PRIMARY	3
SECONDARY DOT	1
SECONDARY	3

**Outline Drawing AT224** 

D TYP

R

.150

н

.065

1.65

A .150

3.81 3.81

.028

0.71

G

PCB L and Pattern

Suggested Layout, Tolerance to be within ±.002

Outline Dimensions (inch)

п

к

.050

1.27

.030

0.76

F

.030

0.76

E

.025

0.64

arams

0.10

wt

С

.1

Config. D

SEC

.190

4.83

.150

3.81

E TYP

PAD SHAPE MAY VARY

H-K TYP 

н түр

Ø

\_\_\_\_\_G TYP

### **Features**

- wideband 2-1100 MHz
- good return loss
- terminations, solder plated with nickel barrier for solderability and excellent leach resistance
- step-down autotransformer
- aqueous washable

#### **Applications**

#### cellular



TC4-11

CASE STYLE: AT224 PRICE: Contact Sales Dept.

Transformer Electrical Specifications						
Ω	FREQUENCY	INSERTION LOSS*				
RATIO (Primary/Secondary)	(MHz)	3 dB MHz	2 dB MHz	1 dB MHz		
50/12.5	2-1100	—	2-1100	5-700		

\* Insertion Loss is referenced to mid-band loss, 0.4 dB typ. Stepdown, 50 ohm primary, 5.2 pF across secondary



#### **Typical Performance Data** FREQUENCY INSERTION INPUT (MHz) LOSS R. LOSS (dB) (dB) 20.35 1.00 0.63 5.00 0.36 31.19 50.00 0.37 40.18 100.00 0.39 36.30 300.00 0.43 26.86 500.00 0.53 21.49 700.00 800.00 0.64 18.96 071 18 37 1000.00 0.89 19.97 1120.00 1.10 19.69 TC4-11 TC4-11 INSERTION LOSS INPUT RETURN LOSS 1.5 50 (gp 1.2 (qB) 40 NSERTION LOSS RETURN LOSS 0.9 30 20 0.6 10 0.3 0 0.0 0 300 600 900 1200 0 300 900 1200 600 FREQUENCY (MHz)



FREQUENCY (MHz)

For detailed performance specs

IF/RF MICROWAVE COMPONENTS Notes: 1. Performance and quality attributes and conditions not expressly stated in this specification sheet are intended to be excluded and do not form a part of this specification sheet. 2. Electrical specifications and performance data contained herein are based on Mini-Circuit's applicable established tests performance criteria and measurement instructions. 3. The parts covered by this specification sheet are subject to Mini-Circuit's and terms and conditions (collective), "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and performance therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuit's website at www.minicircuits.com/MCLStore/terms.jsp.



### **RF Transformer**

Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	RETURN LOSS (dB)
1.00	0.63	20.35
5.00	0.36	31.19
50.00	0.37	40.18
100.00	0.39	36.30
300.00	0.43	26.86
500.00	0.53	21.49
700.00	0.64	18.96
800.00	0.71	18.37
1000.00	0.89	19.97
1120.00	1.10	19.69

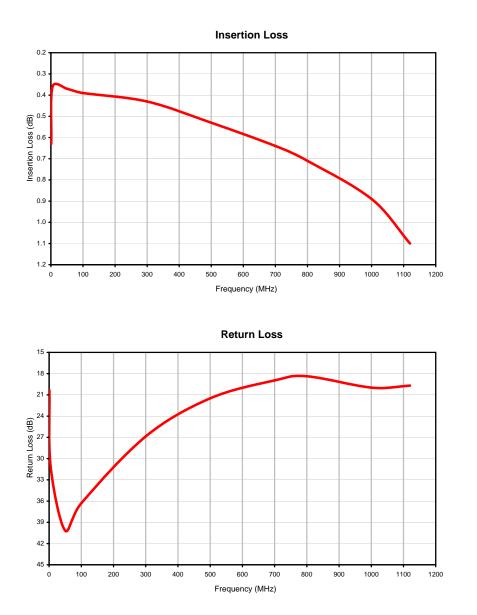


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### **RF** Transformer

Typical Performance Curves





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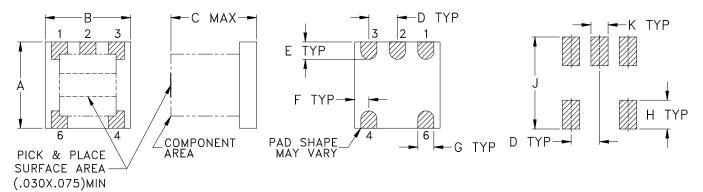
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## Case Style

### **Outline Dimensions**

**PCB Land Pattern** 

AT224



Suggested Layout, Tolerance to be within ±.002

CASE #	А	В	С	D	Е	F	G	Н	J	K	L	WT. GRAMS
AT224	.150 (3.81)	.150 (3.81)	.150 (3.81)	.050 (1.27)	.030 (0.76)	.025 (0.64)	.028 (0.71)	.065 (1.65)	.190 (4.83)	.030 (0.76)		.10

Dimensions are in inches (mm). Tolerances: 2 Pl. + .01; 3 Pl. + .005

#### Notes:

- 1. Open style, ceramic base.
- 2. Termination finish:

For RoHS Case Styles: 2-10  $\mu$  inch (.05-.25 microns) Gold over 100-300  $\mu$  inch (2.54-7.62 microns) Nickel plate. All models, (+) suffix.

For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.





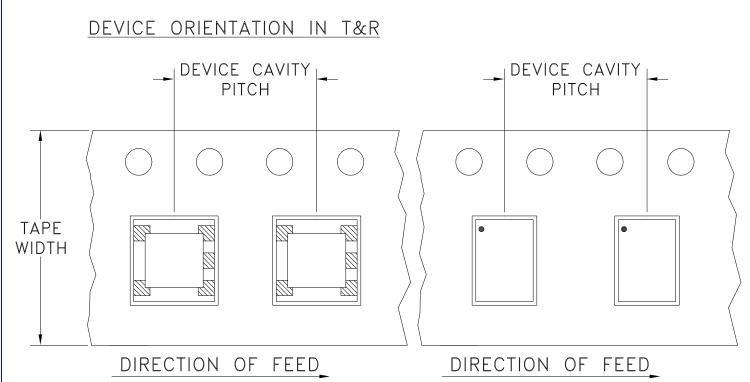
P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site
The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com



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# Tape & Reel Packaging TR-F17



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices	s per Reel
			Small	20
			quantity	50
		7	standards	100
12	8		(see note)	200
				500
		13	Standard	1000
		13	Standard	2000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf





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**RF/IF MICROWAVE COMPONENTS** 

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### Mini-Circuits

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec	
Operating Temperature	-20° to 85°C Ambient Environment	Individual Model Data Sheet	
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet	
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours	
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C	
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1	
Solderability	10X Magnification	J-STD-002, 95% Coverage	
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D	
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A	
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215	
ENV02 Rev: A 02/25/11 M130240 File: ENV			

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